# **2.5 Volt Reference**

The NCV1009 is a precision trimmed 2.5 V  $\pm$ 5.0 mV shunt regulator diode. The low dynamic impedance and wide operating current range enhances its versatility. The tight reference tolerance is achieved by on-chip trimming which minimizes voltage tolerance and temperature drift.

A third terminal allows the reference voltage to be adjusted  $\pm 5.0\%$  to calibrate out system errors. In many applications, the NCV1009Z can be used as a pin-to-pin replacement of the LT1009CZ and the LM136Z-2.5 with the external trim network eliminated.

#### Features

- 0.2% Initial Tolerance Max.
- Guaranteed Temperature Stability
- Maximum 0.6 Ω Dynamic Impedance
- Wide Operating Current Range
- Directly Interchangeable with LT1009 and LM136 for Improved Performance
- No Adjustments Needed for Minimum Temperature Coefficient
- Meets Mil Std 883C ESD Requirements
- Extended Operating Temperature Range for Use in Automotive Applications
- NCV Prefix, for Automotive and Other Applications Requiring Site and Change Control



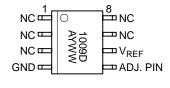
## ON Semiconductor®

http://onsemi.com



#### SO-8 D SUFFIX CASE 751

#### PIN CONNECTIONS AND MARKING DIAGRAM

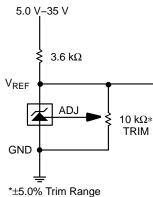


А	= Assembly Location
Υ	= Year
WW	= Work Week

#### **ORDERING INFORMATION**

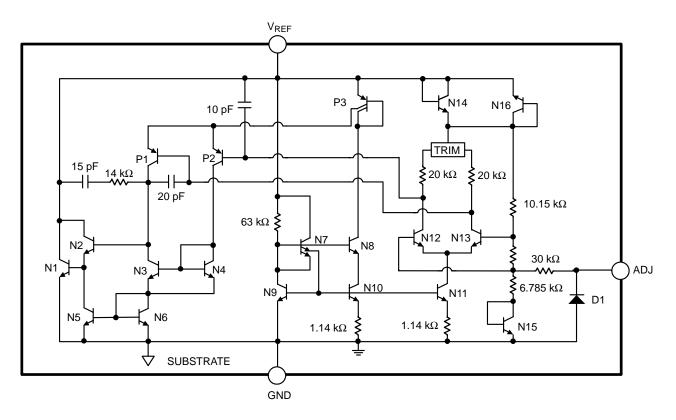
Device	Package	Shipping <sup>†</sup>
NCV1009D	SO-8	95 Units/Rail
NCV1009DR2	SO-8	2500 Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.



If the external trim resistor is not used, the "ADJ. PIN" should be left floating. The 10k trim potentiometer does not effect the temperature coefficient of the device.







#### **MAXIMUM RATINGS\***

Rating	Value	Unit
Reverse Current	20	mA
Forward	10	mA
Package Thermal Resistance, SO–8: Junction–to–Case, R <sub>θJC</sub> Junction–to–Ambient, R <sub>θJA</sub>	45 165	°C/W °C/W
Operating Temperature Range	-40 to +125	°C
Storage Temperature Range	-65 to +150	°C
Lead Temperature Soldering:      Wave Solder (through hole styles only) (Note 1)        Reflow: (SMD styles only) (Notes 2, 3)		°C ℃

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

1. 10 second maximum

2. 60 second maximum above 183°C.

3.  $-5^{\circ}C$  /  $+0^{\circ}C$  allowable conditions.

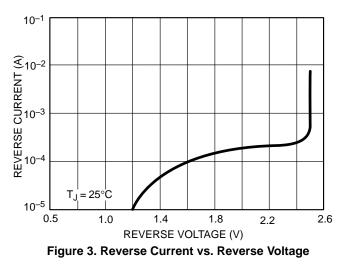
\*The maximum package power dissipation must be observed.

#### **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise specified.)

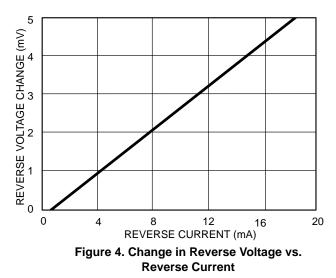
Characteristic	Test Conditions		Min	Тур	Max	Unit
Reverse Breakdown Voltage	I <sub>R</sub> = 1.0 mA		2.492	2.500	2.508	V
Reverse Breakdown Voltage	$0^\circ C \leq T_A \leq 125^\circ C$		2.492	2.500	2.508	V
Reverse Breakdown Voltage	$-40^\circ C \leq T_A \leq 0^\circ C$		2.480	2.500	2.508	V
Reverse Breakdown Voltage Change with Current	$400 \ \mu A \leq I_R \leq 10 \ mA$	†		2.6 3.0	5.0 6.0	mV mV
Reverse Dynamic Impedance	I <sub>R</sub> = 1.0 mA	†	_ _	0.2 0.4	1.0 1.4	Ω Ω
Temperature Stability Average Temperature Coefficient	$\begin{array}{l} 0^{\circ}C \leq T_{A} \leq 70^{\circ}C, \mbox{ Note 4} \\ 0^{\circ}C \leq T_{A} \leq 70^{\circ}C, \mbox{ Note 4} \end{array}$			1.8 15	- -	mV ppm/°C
Long Term Stabilty	$T_A = 25^{\circ}C \pm 0.1 \text{ C}, I_R = 1.0 \text{ mA}$		-	20	-	ppm/kHr

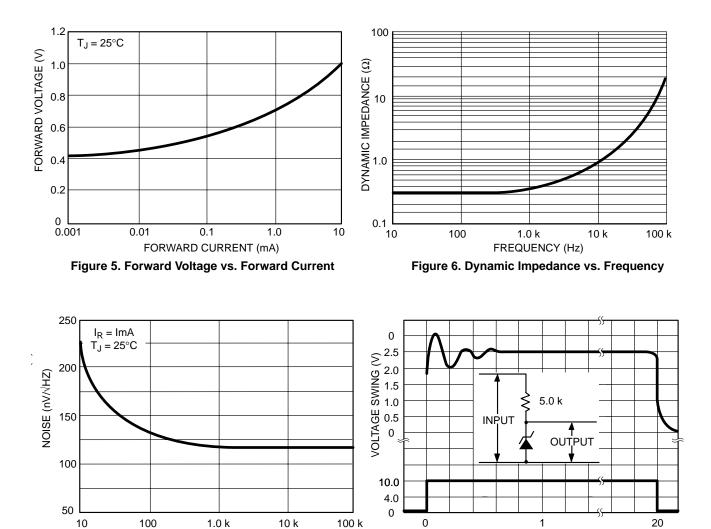
† Denotes the specifications which apply over full operating temperature range.

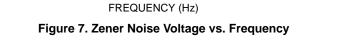
4. Average temperature coefficient is defined as the total voltage change divided by the specified temperature range.



### **TYPICAL PERFORMANCE CHARACTERISTICS**

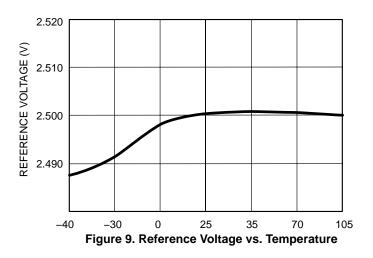






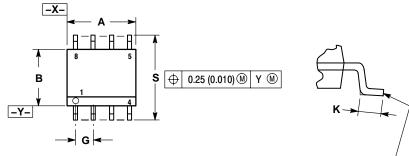
TIME (µs) Figure 8. Response Time

1



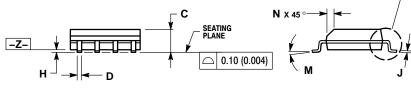
### PACKAGE DIMENSIONS

SO-8 **D SUFFIX** CASE 751-07 **ISSUE AC** 



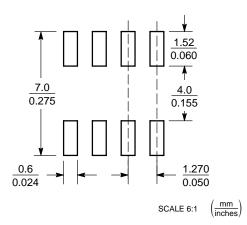
- NOTES:
  DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  CONTROLLING DIMENSION: MILLIMETER.
  DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
  MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
  DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
  751-01 THRU 751-06 ARE OBSOLETE. NEW STANDARD IS 751-07

	MILLIN	IETERS	INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	4.80	5.00	0.189	0.197		
В	3.80	4.00	0.150	0.157		
С	1.35	1.75	0.053	0.069		
D	0.33	0.51	0.013	0.020		
G	1.27	1.27 BSC		0.050 BSC		
Н	0.10	0.25	0.004	0.010		
J	0.19	0.25	0.007	0.010		
K	0.40	1.27	0.016	0.050		
Μ	0 °	8 °	0 °	8 °		
Ν	0.25	0.50	0.010	0.020		
S	5.80	6.20	0.228	0.244		



⊕ 0.25 (0.010) M Z Y S X S

SOLDERING FOOTPRINT



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